



Product Change Notification

Change Notification #: 118722-00
Change Title: Select Intel® SSD D3-S4520 Series and Intel® SSD D3-S4620 Series
PCN 118722-00, Product Material,
Adding 2nd source components and adding 2.5” case surface treatment
Date of Publication: December 09, 2021

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	February 08, 2022
--	-------------------

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- All M.2 SKUs adding the following alternate components:

Component Type	Use Case	Current Component(s)	Alternate Component(s)	Affected MM#s
MOSFET	Vcap FET	Diodes, Inc. (J53658-001)	Toshiba (M59118-001) Infineon (J88109-001)	99A0DD, 99A0DF
Circuit Protection Diode	3.3V Host	Diodes, Inc./ON Semi (G24376-001)	Nexperia (M59419-001)	

- All 2.5” SKUs adding the following alternate components:

Type	Use Case	Current Component(s)	Alternate Component(s)	Affected MM#s
MOSFET	Vcap FET	Diodes, Inc (J53658-001)	Toshiba (M59118-001)	99A0D8, 99A0D9, 99A0DA, 99A0DC, 99A0AA, 99A0AD, 99A0AF, 99A0CP, 99A0D6, 99A0D7
Case Surface Treatment	N/A	N/A	N/A	

Current Case (Untreated)	Case with Needle Barrel Polishing
 A photograph of a rectangular metal case, likely a server component, showing a dull, untreated surface. It has a gold-plated connector strip at the top and four mounting holes. A small Intel logo is visible near the bottom center.	 Two photographs of the same metal case after needle barrel polishing. The top image shows the case with a bright, reflective finish and the marking "B 01" at the top. The bottom image shows the case from a different angle, highlighting the smooth, polished surface.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD D3-S4520 Series (240GB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KB240GZ01	99A0AA
Intel® SSD D3-S4520 Series (480GB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KB480GZ01	99A0AD
Intel® SSD D3-S4520 Series (960GB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KB960GZ01	99A0AF
Intel® SSD D3-S4520 Series (1.92TB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KB019TZ01	99A0CP
Intel® SSD D3-S4520 Series (3.84TB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KB038TZ01	99A0D6
Intel® SSD D3-S4520 Series (7.68TB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KB076TZ01	99A0D7
Intel® SSD D3-S4620 Series (480GB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KG480GZ01	99A0D8
Intel® SSD D3-S4620 Series (960GB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KG960GZ01	99A0D9
Intel® SSD D3-S4620 Series (1.92TB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KG019TZ01	99A0DA
Intel® SSD D3-S4620 Series (3.84TB, 2.5in SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSC2KG038TZ01	99A0DC
Intel® SSD D3-S4520 Series (240GB, M.2 80mm SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSCCKB240GZ01	99A0DD
Intel® SSD D3-S4520 Series (480GB, M.2 80mm SATA 6Gb/s, 3D4, TLC) Generic Single Pack	SSDSCCKB480GZ01	99A0DF

PCN Revision History:

Date of Revision:

December 09, 2021

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

118722-00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jcb.ijkk@intel.com

Copyright © Intel Corporation 2021. Other names and brands may be claimed as the property of others.

3D XPoint, Axxia, Basis, Basis Peak, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, Curie, Flexpipe, Intel, the Intel logo, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Inside, the Intel Inside logo, Intel Insider, Intel Joule, Intel RealSense, Intel SingleDriver, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Iris, Itanium, MCS, MMX, Optane, Ostro, Pali, Pentium, picoArray, Picochip, picoXcell, Puma, Quark, SMARTi, Soletta, Sound Mark, StarPro, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcende, True Key, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS* Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.